# TinyLogic UHS Dual Buffer with 3-STATE Outputs

#### Description

The NC7WZ241 is a Dual Non-Inverting Buffer with 3-STATE outputs. The output enable circuitry is organized as active LOW for one buffer and active HIGH for the other buffer, thus facilitating transceiver operation.

The Ultra High Speed device is fabricated with advanced CMOS technology to achieve superior switching performance with high output drive while maintaining low static power dissipation over a broad  $V_{CC}$  operating range. The device is specified to operate over the 1.65 V to 5.5 V  $V_{CC}$  operating range. The inputs and outputs are high impedance when  $V_{CC}$  is 0 V. Inputs tolerate voltages up to 5.5 V independent of  $V_{CC}$  operating range. Outputs tolerate voltages above  $V_{CC}$  when in the 3–STATE condition.

#### **Features**

- Space Saving US8 Surface Mount Package
- MicroPak<sup>TM</sup> Pb-Free Leadless Package
- Ultra High Speed: t<sub>PD</sub> 2.6 ns Typ. into 50 pF at 5 V V<sub>CC</sub>
- High Output Drive: ±24 mA at 3 V V<sub>CC</sub>
- Broad V<sub>CC</sub> Operating Range: 1.65 V to 5.5 V
- Matches the Performance of LCX when Operated at 3.3 V V<sub>CC</sub>
- Power Down High Impedance Inputs / Outputs
- Overvoltage Tolerant Inputs Facilitate 5 V to 3 V Translation
- Outputs are Overvoltage Tolerant in 3-STATE Mode
- Patented Noise / EMI Reduction Circuitry Implemented
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



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#### MARKING DIAGRAMS



UQFN8 1.6X1.6, 0.5P CASE 523AY





US8 CASE 846AN



T7, WZ41 = Specific Device Code

KK = 2-Digit Lot Run Traceability Code XY = 2-Digit Date Code Format Z = Assembly Plant Code

#### **ORDERING INFORMATION**

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet.

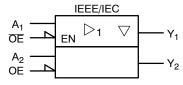


Figure 1. Logic Symbol

# **Connection Diagrams**

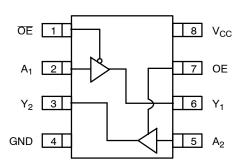


Figure 2. Pin Assignments for US8 (Top View)

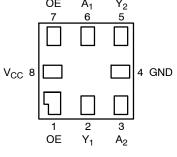
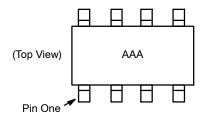


Figure 4. Pad Assignments for MicroPak (Top Thru View)



AAA represents Product Code Top Mark - see ordering code

NOTE: Orientation of Top Mark determines Pin One location. Read the top product code mark left to right, Pin One is the lower left pin (see diagram).

Figure 3. Pin One Orientation Diagram

# **PIN DESCRIPTIONS**

Pin Names	Description
ŌĒ, OE	Enable Inputs for 3-STATE Outputs
A <sub>n</sub>	Inputs
Y <sub>n</sub>	3-STATE Outputs

# **FUNCTION TABLE**

Inputs		Out	put
OE or OE	A <sub>n</sub>	Υ <sub>1</sub>	Y <sub>2</sub>
L	L	L	Z
L	Н	Н	Z
Н	L	Z	L
Н	Н	Z	Н

H = HIGH Logic Level L = LOW Logic Level

Z = 3-STATE

#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Para	nmeter	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage		-0.5	6.5	V
V <sub>IN</sub>	DC Input Voltage (Note 1)		-0.5	6.5	V
V <sub>OUT</sub>	DC Output Voltage		-0.5	6.5	V
I <sub>IK</sub>	DC Input Diode Current V <sub>IN</sub> < 0 V		=	-50	mA
I <sub>OK</sub>	DC Output Diode Current	V <sub>OUT</sub> < 0 V	=	-50	mA
I <sub>OUT</sub>	DC Output Source / Sink Curre	ent	=	±50	mA
I <sub>CC</sub> / I <sub>GND</sub>	DC V <sub>CC</sub> / GND Current		=	±100	mA
T <sub>STG</sub>	Storage Temperature Range		-65	+150	°C
TJ	Junction Temperature under Bi	as	=	+150	°C
TL	Junction Lead Temperature (So	oldering, 10 Seconds)	-	+260	°C
$P_{D}$	Power Dissipation @ +85°C		_	250	mW

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The input and output negative voltage ratings may be exceeded is the input and output diode current ratings are observed.

# **RECOMMENDED OPERATING CONDITIONS**

Symbol		Parameter	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage Operating		1.65	5.5	V
	Supply Voltage Data Retention		1.5	5.5	
V <sub>IN</sub>	Input Voltage		0	5.5	V
V <sub>OUT</sub>	Output Voltage	Active State	0	V <sub>CC</sub>	V
		3-State	0	5.5	V
T <sub>A</sub>	Operating Temperature		-40	+85	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Time	V <sub>CC</sub> = 1.8 V, 0.15 V, 2.5 V ±0.2 V	0	20	ns/V
		V <sub>CC</sub> = 3.8 V ±0.3 V	0	10	1
		V <sub>CC</sub> = 5.0 V ±0.5 V	0	5	
$\theta_{\sf JA}$	Thermal Resistance		-	250	°C/W

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

<sup>2.</sup> Unused inputs must be held HIGH or LOW. They may not float.

# DC ELECTICAL CHARACTERISTICS

					Т,	գ = +25°	С	T <sub>A</sub> = -40	to +85°C	
Symbol	Parameter	Cond	litions	V <sub>CC</sub> (V)	Min	Тур	Max	Min	Max	Unit
V <sub>IH</sub>	HIGH Level Input			1.65 to 1.95	0.65 V <sub>CC</sub>	-	_	0.65 V <sub>CC</sub>	=	V
	Voltage			2.3 to 5.5	0.7 V <sub>CC</sub>	-	_	0.7 V <sub>CC</sub>	=	
$V_{IL}$	LOW Level Input			1.65 to 1.95	-	-	0.35 V <sub>CC</sub>	-	0.35 V <sub>CC</sub>	V
	Voltage			2.3 to 5.5	_	-	0.3 V <sub>CC</sub>	-	0.3 V <sub>CC</sub>	
V <sub>OH</sub>	HIGH Level Output	$V_{IN} = V_{IH}$ or	$I_{OH} = -100 \mu A$	1.65	1.55	1.65	_	1.55	=	V
	Voltage	V <sub>IL</sub>		2.3	2.2	2.3	_	2.2	=	
				3.0	2.9	3.0	_	2.9	=	
				4.5	4.4	4.5	_	4.4	-	
		V <sub>IN</sub> = V <sub>IH</sub> or	$I_{OH} = -4 \text{ mA}$	1.65	1.29	1.52	_	1.29	-	
		V <sub>IL</sub>	I <sub>OH</sub> = -8 mA	2.3	1.9	2.15	_	1.9	=	
			I <sub>OH</sub> = -16 mA	3.0	2.4	2.80	_	2.4	-	
			I <sub>OH</sub> = -24 mA	3.0	2.3	2.68	_	2.3	-	
			$I_{OH} = -32 \text{ mA}$	4.5	3.8	4.20	_	3.8	-	
V <sub>OL</sub>	LOW Level Output	$V_{IN} = V_{IH}$ or	I <sub>OL</sub> = 100 μA	1.65	_	0.0	0.10	=	0.10	٧
	Voltage	V <sub>IL</sub>		2.3	_	0.0	0.10	=	0.10	
				3.0	_	0.0	0.10	=	0.10	
				4.5	-	0.0	0.10	-	0.10	
		V <sub>IN</sub> = V <sub>IH</sub> or	I <sub>OL</sub> = 4 mA	1.65	-	0.08	0.24	-	0.24	
		V <sub>IL</sub>	I <sub>OL</sub> = 8 mA	2.3	_	0.10	0.3	-	0.3	
			I <sub>OL</sub> = 16 mA	3.0	_	0.15	0.4	-	0.4	
			I <sub>OL</sub> = 24 mA	3.0	_	0.22	0.55	-	0.55	
			I <sub>OL</sub> = 32 mA	4.5	_	0.22	0.55	-	0.55	
I <sub>IN</sub>	Input Leakage Current	V <sub>IN</sub> = 5.5 V, G	ND	1.65 to 5.5	-	-	±0.1	-	±1	μΑ
I <sub>OZ</sub>	3-STATE Output Leakage	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $0 \le V_{OUT} \le 5.5 \text{ V}$		1.65 to 5.5	-	-	±0.5	-	±5	μΑ
l <sub>OFF</sub>	Power Off Leakage Current	V <sub>IN</sub> or V <sub>OUT</sub> = 5.5 V		0.0	-	-	1	-	10	μΑ
I <sub>CC</sub>	Quiescent Supply Current	V <sub>IN</sub> = 5.5 V, GI	ND	1.65 to 5.5	-	-	1	-	10	μΑ

# **NOISE CHARACTERISTICS**

				T <sub>A</sub> = +25°C		
Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Тур	Max	Unit
V <sub>OLP</sub> (Note 3)	Quiet Output Maximum Dynamic V <sub>OL</sub>	C <sub>L</sub> = 50 pF	5.0	-	1.0	V
V <sub>OLV</sub> (Note 3)	Quiet Output Minimum Dynamic V <sub>OL</sub>	C <sub>L</sub> = 50 pF	5.0	-	1.0	V
V <sub>OHV</sub> (Note 3)	Quiet Output Minimum Dynamic V <sub>OH</sub>	C <sub>L</sub> = 50 pF	5.0	-	4.0	V
V <sub>IHD</sub> (Note 3)	Minimum HIGH Level Dynamic Input Voltage	C <sub>L</sub> = 50 pF	5.0	-	3.5	V
V <sub>ILD</sub> (Note 3)	Maximum LOW Level Dynamic Input Voltage	C <sub>L</sub> = 50 pF	5.0	_	1.5	V

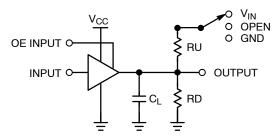
<sup>3.</sup> Parameter guaranteed by design.

# **AC ELECTRICAL CHARACTERISTICS**

					T <sub>A</sub> = +25°C	;	T <sub>A</sub> = -40	to +85°C		
Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Min	Тур	Max	Min	Max	Unit	
t <sub>PLH</sub>	t <sub>PLH</sub> Propagation Delay t <sub>PHL</sub> A <sub>n</sub> to Y <sub>n</sub> (Figure 5, 7)	C <sub>L</sub> = 15 pF	1.8 ±0.15	-	-	12.0	-	13.0	ns	
₹PHL		$RD = 1 M\Omega$ $S_1 = OPEN$	2.5 ±0.2	-	-	7.5	-	8.0		
			3.3 ±0.3	_	-	5.2	-	5.5		
			5.0 ±0.5	_	-	4.5	-	4.8		
		C <sub>L</sub> = 50 pF,	3.3 ±0.3	_	-	5.7	-	6.0		
		RD = $500 \Omega$ S <sub>1</sub> = OPEN	5.0 ±0.5	-	-	5.0	-	5.3		
toslh	Output to Output Skew	C <sub>L</sub> = 50 pF,	3.3 ±0.3	_	-	1.0	-	1.0	ns	
toshl	(Note 4) (Figure 5, 7)	RD = $500 \Omega$ S <sub>1</sub> = Open	5.0 ±0.5	_	-	0.8	_	0.8		
t <sub>PZL</sub>	Output Enable Time (Figure 5, 7)		1.8 ±0.15	_	-	14.0	_	15.0	ns	
t <sub>PZH</sub>		RD,RU = 500 $\Omega$ S <sub>1</sub> = GND for t <sub>PZH</sub>	RD,RU = 500 $\Omega$ S <sub>1</sub> = GND for t <sub>PZH</sub>	2.5 ±0.2	-	-	8.5	_	9.0	
		$S_1 = V_1 \text{ for } t_{PZL}$ $V_1 = 2 \times V_{CC}$	3.3 ±0.3	_	-	6.2	-	6.5	1	
		1, 1, 1, 1, 1, 1, 1, 1, 1, 1, 1, 1, 1, 1	5.0 ±0.5	-	-	5.5	-	5.8		
t <sub>PLZ</sub>	Output Disable Time	C <sub>L</sub> = 50 pF	1.8 ±0.15	-	-	12.0	-	13.0	ns	
t <sub>PHZ</sub>	(Figure 5, 7)	RD,RU = 500 $\Omega$ S <sub>1</sub> = GND for t <sub>PHZ</sub>	2.5 ±0.2	-	-	8.0	-	8.5		
		$S_1 = V_I \text{ for } t_{PLZ}$ $V_I = 2 \times V_{CC}$	3.3 ±0.3	_	-	5.7	-	6.0		
			5.0 ±0.5	-	-	4.7	-	5.0		
C <sub>IN</sub>	Input Capacitance		0	-	2.5	-	-	-	pF	
C <sub>OUT</sub>	Output Capacitance		5.0	-	4	-	-	-	pF	
C <sub>PD</sub>	Power Dissipation	OE = GND	3.3	-	10	-	-	_	pF	
	Capacitance (Note 5) (Figure 6)	OE = V <sub>CC</sub>	5.0	-	12	-	-	-		

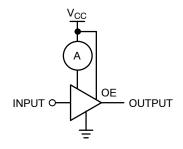
 <sup>4.</sup> Parameter guaranteed by design. t<sub>OSLH</sub> = |t<sub>PLHmax</sub> - t<sub>PLHmin</sub>|; t<sub>OSHL</sub> = |t<sub>PHLmax</sub> - t<sub>PHLmin</sub>|.
 5. C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I<sub>CCD</sub>) at no output loading and operating at 50% duty cycle. (see Figure 6) C<sub>PD</sub> is related to I<sub>CCD</sub> dynamic operating current by the expression: I<sub>CCD</sub> = (CPD) (V<sub>CC</sub>) (f<sub>IN</sub>) + (I<sub>CC</sub>static).

# **AC Loading and Waveforms**



 $C_L$  includes load and stray capacitance Input PRR = 1.0 MHz;  $t_W$  = 500 ns

Figure 5. AC Test Circuit



Input = AC Waveform;  $t_r = t_f = 1.8$  ns; PRR = 10 MHz; Duty Cycle = 50%.

Figure 6. I<sub>CCD</sub> Test Circuit

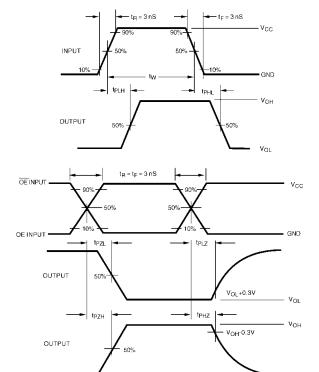


Figure 7. AC Waveforms

# **ORDERING INFORMATION**

Order Number	Top Mark	Package	Shipping <sup>†</sup>
NC7WZ241K8X	WZ41	8-Lead US8, JEDEC MO-187, Variation CA 3.1 mm Wide	3000 / Tape & Reel
NC7WZ241L8X	T7	8-Lead MicroPak, 1.6 mm Wide (Pb-Free)	5000 / Tape & Reel

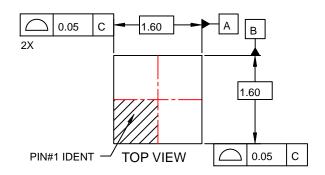
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

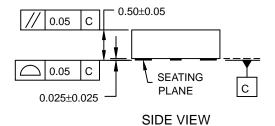
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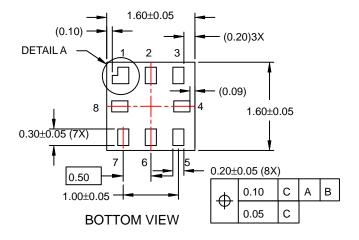
<sup>6.</sup> Pb-Free package per JEDEC J-STD-020B.

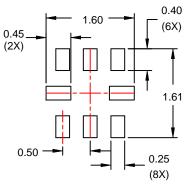
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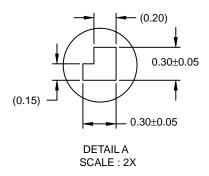




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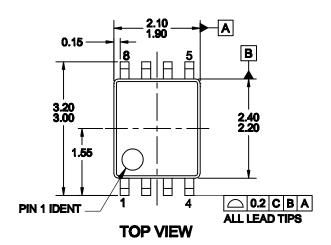
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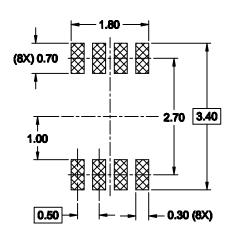
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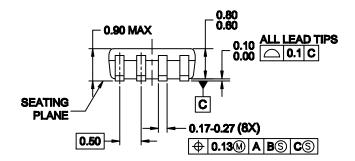
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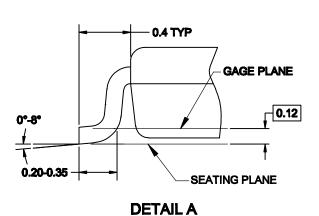
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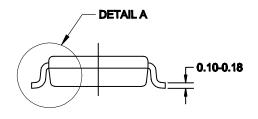


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